

# FGA30N60LSD 600 V, 30 A PT IGBT

## Features

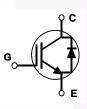
- Low Saturation Voltage: V<sub>CE(sat)</sub> = 1.1 V @ I<sub>C</sub> = 30 A
- High Input Impedance
- Low Conduction Loss

### **Applications**

Solar Inverter, UPS

### November 2013





Using Fairchild's advanced PT technology, the FGA30N60LSD

IGBT offers superior conduction performances, which offer the optimum performance for medium switching application such as

solar inverter, UPS applications where low conduction losses

**General Description** 

are the most important factor.

## **Absolute Maximum Ratings**

Symbol	Description		Description Ratings	
V <sub>CES</sub>	Collector-Emitter Voltage		600	V
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V
I <sub>C</sub>	Collector Current	@ $T_{C} = 25^{\circ}C$	60	A
	Collector Current	@ T <sub>C</sub> = 100°C	30	A
I <sub>CM (1)</sub>	Pulsed Collector Current		90	A
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave		150	A
P <sub>D</sub>	Maximum Power Dissipation	@ $T_{C} = 25^{\circ}C$	480	W
	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	192	W
TJ	Operating Junction Temperature		-55 to +150	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

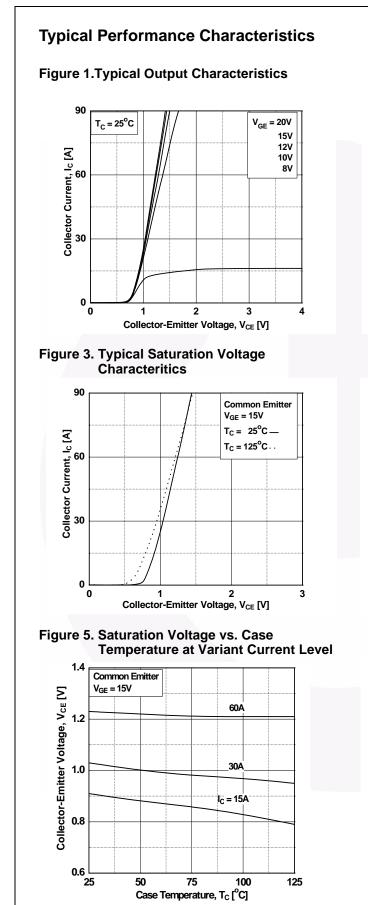
## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>θJC</sub> (IGBT) Thermal Resistance, Junction-to-Case			0.26	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction-to-Case		0.92	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Part NumberTop MarkPackageFGA30N60LSDTUFGA30N60LSDTO-3P		Top Mark	Package	e Packing Method	Reel Size	Tape Width		Quantity	
		TO-3P	Tube	N/A	N/A		30		
Electric	al Cha	racteristics	of the IG	<b>BT</b> T <sub>C</sub> = 25°C unless otherw	ise noted				
Symbol				Test Condition	s Min.	Тур. Ма		x. Unit	
Off Charac	toristics				<u> </u>		+		
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage		n Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 uA	600			V	
ΔB <sub>VCES</sub> / ΔT <sub>J</sub>	Temperature Coefficient of Breakdown Voltage		-	$V_{GE} = 0 V, I_C = 250 uA$		0.6		V/°C	
I <sub>CES</sub>	-	r Cut-Off Current		V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V			250	uA	
I <sub>GES</sub>		kage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$ $V_{GE} = V_{GES}, V_{CE} = 0 V$			±250		
On Charac								l	
V <sub>GE(th)</sub>	1	eshold Voltage		$I_{\rm C}$ = 250 uA, $V_{\rm CE}$ = $V_{\rm GE}$	4.0	5.5	7.0	V	
GE(ui)				$I_{\rm C} = 30$ A, $V_{\rm GE} = 15$ V		1.1	1.4	V	
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage		-	$I_{C} = 30 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$		1.0		V	
				I <sub>C</sub> = 60 A, V <sub>GE</sub> = 15 V		1.3		V	
Dynamic C	haracteri	stics			<u> </u>				
C <sub>ies</sub>	Input Capacitance Output Capacitance					3550		pF	
C <sub>oes</sub>			$V_{CE} = 30 V, V_{GE} = 0 V,$ f = 1 MHz		245		pF		
C <sub>res</sub>	Reverse Transfer Capacitance					90		pF	
Switching	Characte	ristics							
t <sub>d(on)</sub>	Turn-On Delay Time Rise Time				18		ns		
t <sub>r</sub>						46		ns	
t <sub>d(off)</sub>	Turn-Off	Turn-Off Delay Time Fall Time Turn-On Switching Loss		V <sub>CC</sub> = 400 V, I <sub>C</sub> = 30 A,		250		ns	
t <sub>f</sub>	Fall Time			$R_{G} = 6.8 \Omega$ , $V_{GE} = 15 V$ ,		1.3	2.0	us	
Eon	Turn-On			Inductive Load, $T_C = 25^{\circ}C$		1.1		mJ	
E <sub>off</sub>	Turn-Off	Switching Loss				21		mJ	
t <sub>d(on)</sub>	Turn-On	Delay Time				17		ns	
t <sub>r</sub>	Rise Time					45		ns	
t <sub>d(off)</sub>	Turn-Off	Turn-Off Delay Time		V <sub>CC</sub> = 400 V, I <sub>C</sub> = 30 A,		270		ns	
t <sub>f</sub>	Fall Time Turn-On Switching Loss		$R_G = 6.8 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 125$ °C		2.6		us		
E <sub>on</sub>				°C	1.1		mJ		
E <sub>off</sub>	Turn-Off	Switching Loss				36		mJ	
Qg	Total Ga	te Charge				225		nC	
Q <sub>ge</sub>	Gate-Em	nitter Charge		$V_{CE} = 300 \text{ V}, I_{C} = 30 \text{ A},$		30		nC	
Q <sub>gc</sub>	Gate-Co	llector Charge		V <sub>GE</sub> = 15 V		105		nC	
L <sub>e</sub>	Internal Emitter Inductance			Measured 5mm from PKG	i	7		nH	

Parameter	Conditions			Тур.	Max	Unit
V <sub>FM</sub>	I <sub>F</sub> = 15 A	T <sub>C</sub> = 25 °C	-	1.8	2.2	V
	I <sub>F</sub> = 15 A	T <sub>C</sub> = 125 °C	-	1.6	-	V
I <sub>RM</sub>	V <sub>R</sub> = 600 V	T <sub>C</sub> = 25 °C	-	-	100	μΑ
t <sub>rr</sub>	I <sub>F</sub> =1 A, di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 30 V	T <sub>C</sub> = 25 °C	-	-	35	ns
	I <sub>F</sub> =15 A, di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 390 V	T <sub>C</sub> = 25 °C	-	-	40	ns
t <sub>a</sub>	I <sub>F</sub> =15 A, di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 390 V	T <sub>C</sub> = 25 °C	-	18	-	ns
t <sub>b</sub>		T <sub>C</sub> = 25 °C	-	13	-	ns
Q <sub>rr</sub>		T <sub>C</sub> = 25 °C	-	27.5	-	nC

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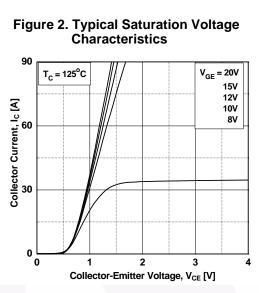


Figure 4. Transfer characteristics

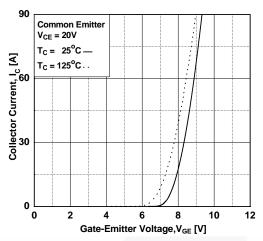
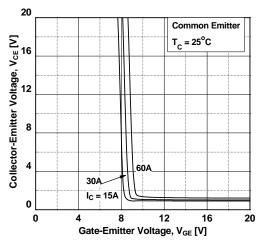


Figure 6. Saturation Voltage vs. Vge



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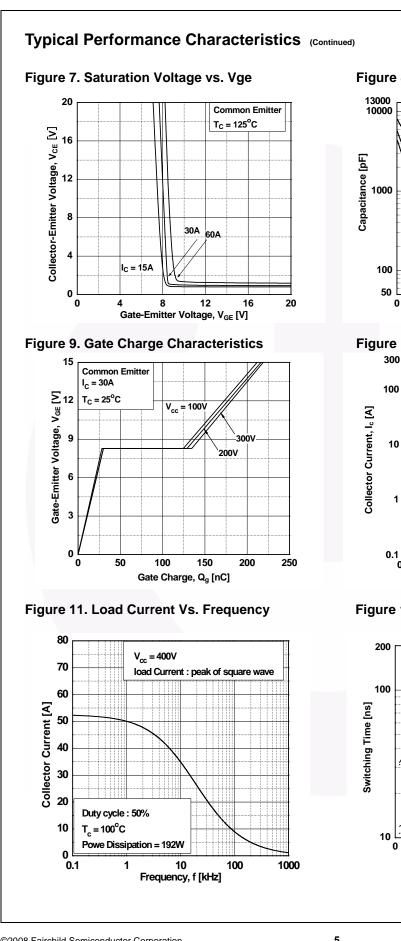


Figure 8. Capacitance characteristics

Common Emitter V<sub>GE</sub> = 0V, f = 1MHz

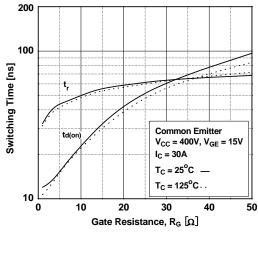
 $T_C = 25^{\circ}C$ 

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30 5 10 15 20 25 Collector-Emitter Voltage, V<sub>CE</sub> [V] Figure 10. SOA Characteeristics Ic MAX (Pulsed) 50µs Ic MAX (Continuous) 100µs 1ms Single Nonrepetitive DC Operation Pulse  $T_c = 25^{\circ}C$ Curves must be derated linearly with increase in temperature 0.1 1 10 100 Collector-Emitter Voltage, V<sub>CE</sub> [V] . 0.1 1000

Figure 12. Turn-On Characteristics vs. **Gate Resistance** 



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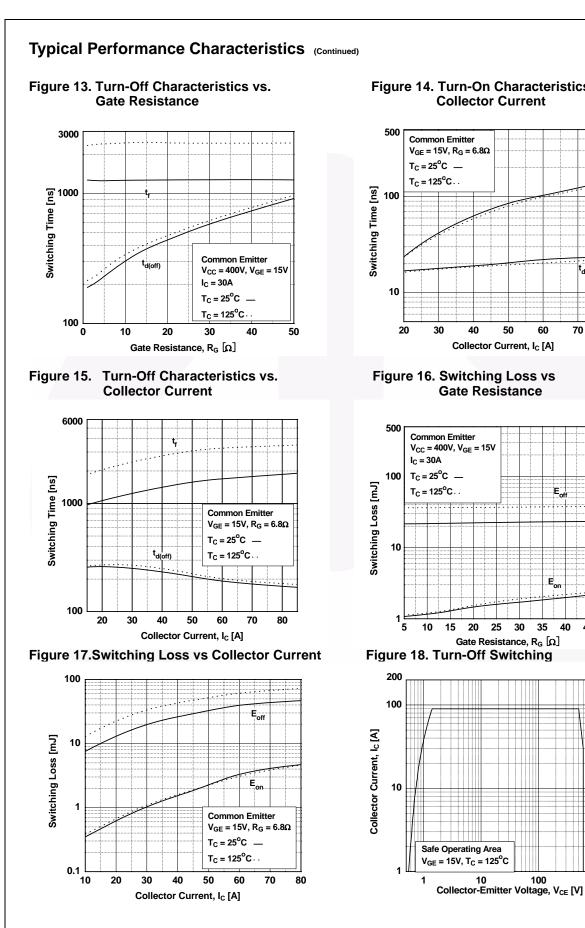


Figure 14. Turn-On Characteristics vs. **Collector Current** 

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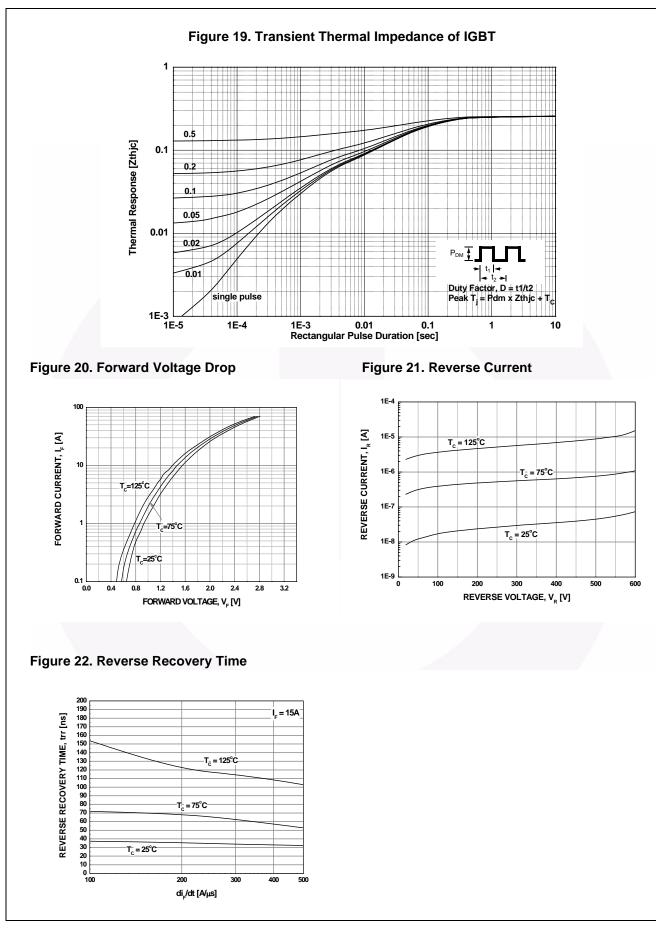
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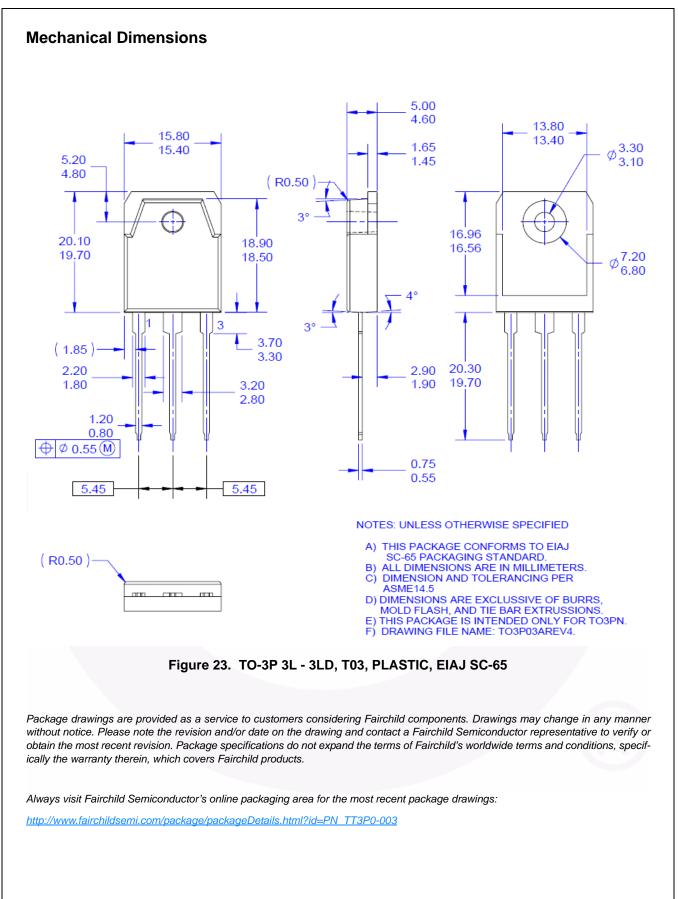
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600 V, 30 A PT IGBT —

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